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**Citation:** FRASTIA, L. ARCHER, A.J. and THIELE, U., 2011. Dynamical model for the formation of patterned deposits at receding contact lines. *Physical Review Letters*, 106, 077801, 4pp.


**Metadata Record:** <https://dspace.lboro.ac.uk/2134/15356>

**Version:** Published

**Publisher:** © American Physical Society

Please cite the published version.

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## Dynamical Model for the Formation of Patterned Deposits at Receding Contact Lines

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(Received 27 August 2010; published 16 February 2011)

We describe the formation of deposition patterns that are observed in many different experiments where a three-phase contact line of a volatile nanoparticle suspension or polymer solution recedes. A dynamical model based on a long-wave approximation predicts the deposition of irregular and regular line patterns due to self-organized pinning-depinning cycles corresponding to a stick-slip motion of the contact line. We analyze how the line pattern properties depend on the evaporation rate and solute concentration.

DOI: [10.1103/PhysRevLett.106.077801](https://doi.org/10.1103/PhysRevLett.106.077801)

PACS numbers: 68.15.+e, 47.57.-s, 81.15.Lm, 81.16.Rf

The last decade has seen huge growth in interest in phenomena that accompany evaporative and convective dewetting of suspensions and solutions. Well known are the detailed studies of the coffee stain effect [1,2] that analyze the deposition and resulting structures left behind by a receding three-phase contact line of an evaporating drop of suspension upon a solid substrate. In particular, Ref. [2] describes a large range of different deposition patterns including cellular and lamellar structures, single and multiple rings, and Sierpinski gaskets. Other observed structures include crack [3] and chevron [4] patterns. Recently it has been shown that evaporating polymer solutions [5–7] and (nano)particle suspensions [8–10] may be used to fabricate strikingly regular stripe patterns, where the deposited stripes are parallel to the receding contact line and have typical distances ranging from 10–100  $\mu\text{m}$ . The goal is to use this effect as a nonlithographic technique for covering large areas with regular arrays of small-scale structures, such as, e.g., concentric gold rings with potential uses as resonators in advanced optical communications systems [11]. The patterns deposited from more complex fluids, such as polymer mixtures [12] and DNA solutions [13], are also investigated. The occurrence of regular stripe patterns is a somewhat generic phenomenon, that is not only observed for different combinations of substances but also in a variety of experimental setups that allow for slow evaporation. Examples include the meniscus technique in a sphere-on-flat geometry [7,9], a controlled continuous supply of liquid between two sliding plates to maintain a meniscuslike surface [5] and dewetting forced by a pressure gradient [10]. Interestingly, besides the stripes parallel to the receding contact line, a variety of other patterns is observed, including regular orthogonal stripes [9], superpositions of orthogonal and parallel stripes [5], regular arrays of drops [5,14] and irregularly branched structures [14,15]. This behavior is highly sensitive to the particular experimental setup and parameters.

Despite the extensive number and variety of experiments, an explanation of the formation of the regular patterns has been rather elusive. Although most studies

agree that the patterns result from a stick-slip motion of the contact line caused by pinning or depinning events [2,6,11,16] no dynamical model of the periodic deposition process exists. Most models assume a permanently pinned contact line (see [17,18] and references therein) and are therefore only able to describe the formation of a single line deposit. A nonisothermal Navier-Stokes simulation shows depinning from such a single line but no periodic deposits [16]. The model of Ref. [19] describes drop arrays formed via directed dewetting of the solvent that are subsequently dried.

In this Letter we discuss a generic close-to-equilibrium model for the evaporative and convective receding of a three-phase contact line of a solution or suspension on a solid substrate. We show that solely having a viscosity that diverges at a critical solute concentration is sufficient to trigger a self-organized periodic pinning-depinning process that results in the deposition of regular line patterns. The model can easily be extended to incorporate other processes and in the future may be employed to assess their influence on the basic mechanism that we describe here.

We consider a thin film of an evaporating partially wetting nanoparticle suspension (or polymer solution) in contact with its vapor on a flat solid substrate (see Fig. 1). Assuming that all surface slopes are small, one may employ a long-wave approximation [20] and derive two coupled evolution equations for the film thickness profile  $h(x, t)$  and the vertically averaged solute concentration field  $\phi(x, t)$ :



FIG. 1. Sketch of a liquid front that recedes due to evaporation and convection with a varying velocity  $v(t)$ . The deposition process is characterized by the film thickness profile  $h(x, t)$ , the concentration profile  $\phi(x, t)$  (in the bulk film), and the particle layer thickness  $h_p(x, t) = \phi(x, t)h(x, t)$  (outside the bulk film).

$$\partial_t h = \partial_x [Q(h, \phi) \partial_x p(h)] - \frac{\beta}{\rho} (p(h) - \mu \rho), \quad (1)$$

$$\partial_t (\phi h) = \partial_x [\phi Q(h, \phi) \partial_x p(h)] + \partial_x [D(\phi) h \partial_x \phi]. \quad (2)$$

The mobility  $Q(h, \phi) = h^3/3\eta(\phi)$  models Poiseuille flow and incorporates the dynamic viscosity  $\eta(\phi)$  that exhibits a strong nonlinear dependence on the local solute concentration. We employ the Krieger-Dougherty law [21,22]

$$\eta(\phi) = \eta_0 (1 - \phi)^{-\nu}, \quad (3)$$

where  $\eta_0$  is the viscosity of the pure solvent. We have scaled  $\phi$  by the concentration at random close packing ( $\phi_c = 0.63$ ) so that  $\eta$  diverges when  $\phi \rightarrow 1$ . The precise value of the exponent  $\nu = [\eta]\phi_c$  depends on the type of suspension. For noninteracting particles (i.e., particles that have no net attractive forces between them and only have excluded volume interactions), values for  $\nu$  between 1.4 and 3 are discussed, depending on the shape of the particles [21]. For spherical particles the factor  $[\eta] = 2.5$ , giving  $\nu = 1.575$ . Other thin film models use  $\nu = 2$  [19,23]. For interacting solute particles, values for  $\nu$  as low as 0.13 are reported [24]. Depending on the particular system, the transition at  $\phi_c$  is either referred to as jamming or gelation [24]. Here we fix  $\nu = 1.575$ , although we have found that the effects we describe below are even stronger for smaller  $\nu$ .

The first term on the right-hand side of Eq. (1) (conserved part) corresponds to convective transport of the liquid whereas the second term (nonconserved part) models evaporation. The convective flow is driven by the gradient of the pressure

$$p(h) = -\gamma \partial_{xx} h - \Pi(h), \quad (4)$$

where the first term is the Laplace pressure ( $\gamma$  is the surface tension) and the second is the disjoining pressure  $\Pi(h) = 2S^{\text{LW}} d_0^2/h^3 + S^{\text{P}} \exp[-(h - d_0)/l_0]/l_0$  that models a partially wetting fluid [25,26]. Here,  $l_0$  is the Debye length,  $d_0$  is a molecular interaction length,  $S^{\text{LW}} = -A/12\pi d_0^2$  and  $S^{\text{P}} < 0$  are the apolar and polar spreading coefficient, respectively, and  $A < 0$  is the Hamaker constant. We expect qualitatively similar behavior if other combinations of stabilizing and destabilizing terms were used in  $\Pi$  (cf. e.g., [27,28]). To derive the second term in Eq. (1) we assume the system is close to equilibrium and near to saturation and so evaporation is slow. In this limit evaporation with a rate  $\beta$  is driven by the difference of the scaled pressure  $p/\rho$  and the chemical potential of the ambient vapor  $\mu$  [29,30]. Latent heat effects may be neglected, and the density  $\rho$  is assumed to be equal for particles and solvent. The first and second terms on the right-hand side of Eq. (2) model convective and diffusive transport of the particles, respectively. Note that the diffusion coefficient depends on concentration and we employ the Einstein-Stokes relation  $D(\phi) = k_B T/6\pi r_0 \eta(\phi)$ , where  $k_B$  is the Boltzmann constant,  $T$  the temperature, and  $r_0$  the particle radius.

Models related to Eqs. (1) and (2) are used in studies of particle-laden film flow [23] (without evaporation or wettability effects) and dewetting of suspensions of surface active particles [19] (different wettability regime). In the limit  $\phi \rightarrow 0$ , our theory reduces to that used in [29] to study the fingering instability of an evaporative front of a pure liquid. We choose our scaling and some of the parameters to be the same as in [29]: The dimensionless chemical potential  $M = \rho \mu / |\tilde{S}^{\text{P}}| = -0.003$ , the diffusion number  $D_0 = 3k_B T/r_0 [6\pi A^2 |\tilde{S}^{\text{P}}|]^{1/3} = 0.0003$ , and the parameter  $\chi = (|A|/6\pi |\tilde{S}^{\text{P}}|)^{1/3}/l_0 = 1.085$  in the dimensionless disjoining pressure,  $1/h^3 - \exp(-\chi h)$ ; where  $\tilde{S}^{\text{P}} = S^{\text{P}} \exp(d_0/l_0)/l_0$  [31]. Our main control parameters are the initial mean (dimensionless) concentration  $\phi_0$  and the evaporation number  $\Omega_0 = 18\pi\beta\eta_0\gamma/\rho [6\pi A^2 |\tilde{S}^{\text{P}}|]^{1/3}$  which represents the ratio of the time scales for convection and evaporation of a film without solute. We solve the nondimensional model by discretizing over a spatial domain of finite length  $L$ . Deposited patterns are obtained by direct time simulations using a variable-step variable-order backward difference scheme starting from an initially step-like front that becomes smooth in the early evolution [32].

In the evaporative dewetting process one encounters different types of receding fronts. In the case without solute [29] one may distinguish the limiting cases of (i) convection-dominated and (ii) evaporation-dominated dewetting for small and large values of  $\Omega_0$ , respectively. In case (i) the front recedes rapidly and convective motion maintains a capillary ridge despite evaporation. In case (ii) convection is much slower than evaporation, the front recedes slowly and there is no capillary ridge. In the presence of a solute the situation is more complex and stationary receding front shapes are not found for some parameter values. In general, on starting with a uniform concentration  $\phi(x, 0) = \phi_0$ , as the front recedes, it deposits part of the solute in a smooth layer. Evaporation in the contact line region increases the local concentration  $\phi$  and consequently also the viscosity. When  $\phi \rightarrow 1$ , the convective motion in the contact region stops completely (the suspension becomes locally jammed) due to the strong nonlinearity in Eq. (3). One may say that the initial convection-dominated stage changes into an evaporation-dominated regime as the local evaporation number  $\Omega = (\eta(\phi)/\eta_0)\Omega_0$  becomes large. At this stage the front seems pinned. However, it is actually still moving extremely slowly, solely by evaporation, and deposits a first line of solute. During this, the local concentration in the contact region decreases, i.e.,  $\Omega$  decreases, until the front depins and convective motion resumes. Subsequently, after the initial line is deposited, various scenarios are possible: (a) a deposit of uniform thickness (i.e., only a single line is deposited), (b) deposition of a finite number of lines followed by a layer of constant thickness, (c) intermittent line pattern, and (d) regular line pattern. In the narrow region of parameter space where the “limiting” case (c) occurs, we find that this behavior is normally very sensitive to computational details [which is not the case for (d)], so we believe that the

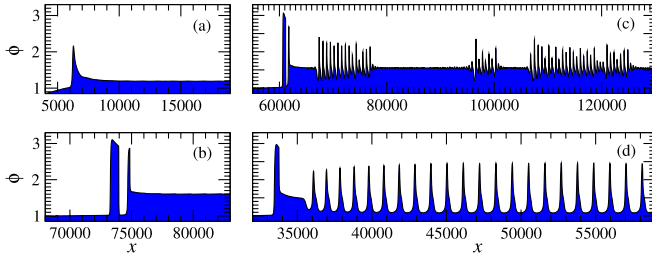


FIG. 2 (color online). Typical deposit profiles: (a) a single line, (b) a finite sequence of lines, (c) an intermittent line pattern, and (d) a regular line pattern. The parameters are  $\phi_0 = 0.41$  and from (a) to (d):  $\Omega_0 = (14.7, 0.1, 0.147, 0.464) \times 10^{-6}$ .

intermittent line patterns represent a “chaotic deposition.” Typical profiles are displayed in Fig. 2 and the corresponding parameter ranges are marked in the phase diagram Fig. 3.

Ignoring initial transients, we distinguish two main types of deposits: those of uniform thickness [regions (a),(b) and (e) in Fig. 3] and periodic line patterns (region (d)). In the latter one observes (as in the experiments [6,10,11]) a regular stick-slip motion of the contact line, since the typical time scales for convection-dominated and evaporation-dominated front motion may differ by orders of magnitude.

Structure formation results from a subtle interplay between convection, evaporation, and diffusion. The basic mechanism of line deposition described above stems from a balance of convective and evaporative motion. Diffusion does not change that picture as long as its time scale is not much shorter than the convective and evaporative time scales. Increasing  $D_0$  merely shrinks the region (d) in Fig. 3. However, in the unlikely situation that diffusion is

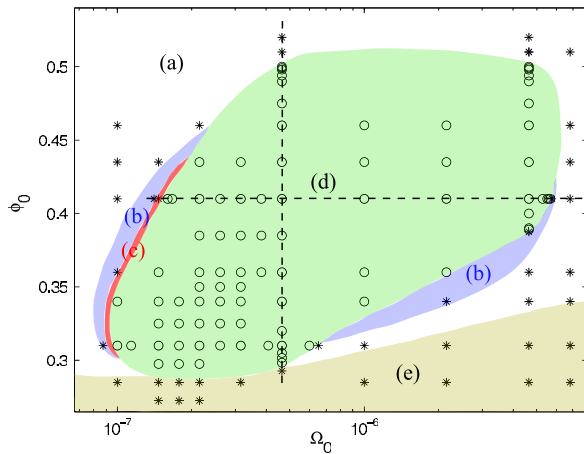


FIG. 3 (color online). Morphological phase diagram of deposition patterns, in the plane spanned by evaporation number  $\Omega_0$  and bulk concentration  $\phi_0$ . Symbols denote performed simulations. In the central region we find (d) regular line patterns (○) and outside of this region (\*) we observe: (a) single lines, (b) multiple lines, (c) intermittent patterns, and (e) no lines. For typical deposit profiles for (a)–(d) see Fig. 2. Results from along the dashed lines are presented in Figs. 4 and 5.

so fast that nanoparticles diffuse away ahead of the receding contact line (e.g., when  $D_0 = 0.3$ ), then line deposition is suppressed. We do not consider this case here.

Next, we analyze regular line patterns as obtained from long-time simulations [32]. Excluding the initial transient we take a sequence of  $N$  regular deposition periods (lines), where  $10 \lesssim N \lesssim 100$ , depending on the period of the deposit and required CPU time. We measure the amplitude, relative width (defined as  $2\sigma/[\text{period}]$ , where  $\sigma$  is the standard deviation) and skewness of the lines, and the period of the line pattern. We find that these quantities strongly depend on both the evaporation number  $\Omega_0$  and the concentration  $\phi_0$ . We focus on two cuts through region (d) in Fig. 3 (dashed lines).

First, we fix  $\Omega_0 = 4.64 \times 10^{-7}$  and vary the bulk concentration  $\phi_0$ . Figure 4 presents line characteristics and selected profiles. On increasing  $\phi_0$  from a region without periodic line deposition, one first finds large amplitude almost solitary peaks separated by very large distances. On further increasing  $\phi_0$ , the amplitude first hardly changes and then later decreases. The period rapidly decreases while the relative line width (not shown) and skewness increase almost linearly, but with a slight drop at very high concentrations  $\phi_0 \gtrsim 0.49$ . For higher  $\phi_0$  the deposit pattern becomes almost uniform, with a small amplitude harmonic modulation. Finally, the amplitude goes to zero (at finite period) at the upper border of region (d).

Second, Fig. 5 presents results for fixed  $\phi_0 = 0.41$  and varying  $\Omega_0$ . Increasing  $\Omega_0$ , moving from the narrow region (b) of multiple lines (Fig. 3), one passes through a very narrow band of intermittent line patterns (c) followed by the region (d) of regular line patterns. For the lowest values of  $\Omega_0$  in (d), the patterns have a relatively small period and a small but nonzero amplitude. The strongly anharmonic peaks are skewed to the right with their tail pointing towards the receding film. On increasing  $\Omega_0$  the period increases. The amplitude, however, first increases and then decreases, until at a certain threshold the pattern ceases

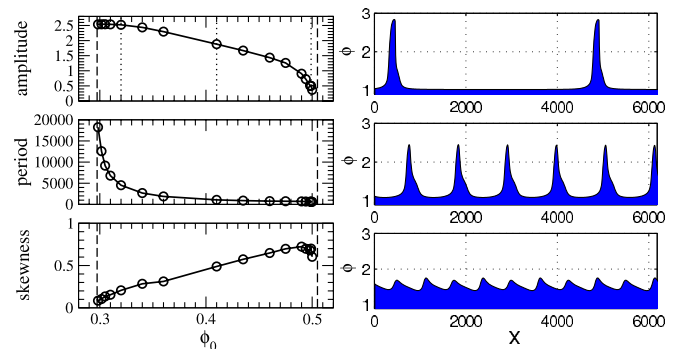


FIG. 4 (color online). Left: dependence of the regular line pattern properties on  $\phi_0$  in the range bounded by the vertical dashed lines that corresponds to region (d) of Fig. 3.  $\Omega_0 = 4.64 \times 10^{-7}$  is fixed. Right: Line patterns for  $\phi_0 = 0.32, 0.41$ , and  $0.499$  (from the top) indicated by dotted lines in the upper left panel.

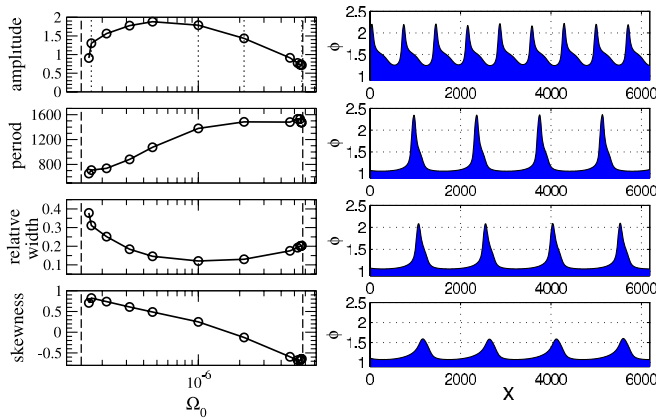


FIG. 5 (color online). Left: dependence of the regular line pattern properties on  $\Omega_0$  in the range bounded by the vertical dashed lines [region (d) of Fig. 3].  $\phi_0 = 0.41$  is fixed. Right: Line patterns for  $\Omega_0 = (0.17, 1.0, 2.15, 5.66) \times 10^{-6}$  (from the top) indicated by dotted lines in the upper left panel.

to be periodic and we arrive in the narrow border region (b), where only a finite number of lines are deposited. Correspondingly, the relative width decreases, as lines get more peaked. Remarkably, the skewness changes sign, i.e., the tail of the lines shifts from pointing towards the receding film, to pointing away. This effect was observed in experiments on nanoparticle suspensions [33] and can be explained as follows: For smaller values of  $\Omega_0$ , the capillary ridge is large and accommodates a large amount of nanoparticles as it recedes. When the front pins, the capillary ridge is evaporated and these nanoparticles are deposited in the thick tail to the right. When the liquid front depins, it results in a further drop in the deposition thickness (seen as a shoulder in the tail). For higher values of  $\Omega_0$  the capillary ridge is smaller and so the right tail is smaller.

Additional simulations varying the parameters  $M$  and  $\chi$  for parameter values where the two dashed lines in Fig. 3 cross, show that the deposition of line patterns is a robust phenomenon: Decreasing  $\chi$  results in a small decrease of the upper film height and (much less so) of the precursor height. The period and amplitude of the line pattern increases. Decreasing  $M$  (i.e., increasing evaporation) leads to an increased amplitude and period of the lines.

In conclusion, we have studied a generic model for the formation of patterned deposits that incorporates wettability, capillarity, evaporation, convective transport of the solution and diffusion of the solute. We find that a strong nonlinear dependence of viscosity (i.e., the front mobility) on concentration triggers, in an intricate interaction with evaporation and diffusion, the deposition of periodic and aperiodic line patterns as observed in experiments for many different materials and settings [2,5–11,33]. We believe that the model explains a basic mechanism for the formation of regular line patterns. They result from a self-organized cycle of deposition-caused pinning-depinning events that is experimentally often described as a stick-slip motion [6,10,11]. In the future the basic

dynamical model should be extended to study the influence of other important effects on the deposition. These include thermal effects, solute-dependent wettability and the nature of the solvent-solute interaction.

We acknowledge support by the EU via the ITN MULTIFLOW (PITN-GA-2008-214919).

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